

Rev. V1

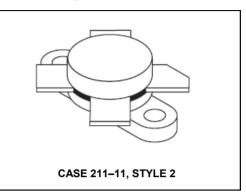
### The RF MOSFET Line 125W, 200MHz

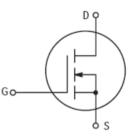
Designed primarily for wideband large–signal output and driver stages up to 200 MHz frequency range.

N-Channel enhancement mode MOSFET

- Guaranteed performance at 150 MHz, 28 Vdc Output power = 125 W Minimum gain = 9.0 dB
- Efficiency = 50% (min.)
- Excellent thermal stability, ideally suited for Class A operation
- Facilitates manual gain control, ALC and modulation techniques
- 100% tested for load mismatch at all phase angles with 30:1 VSWR
- Low noise figure 3.0 dB typ. at 2.0 A, 150 MHz

### Product Image





#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit Vdc	
Drain–Source Voltage	VDSS	65		
Drain–Gate Voltage (R <sub>GS</sub> = 1.0 MΩ)	VDGR	65	Vdc	
Gate-Source Voltage	V <sub>GS</sub>	±40	Vdc	
Drain Current — Continuous	۱D	13	Adc	
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	PD	270 1.54	Watts W/∘C	
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C	
Operating Junction Temperature	Tj	200	°C	

Characteristic	Symbol	Мах	Unit
Thermal Resistance, Junction to Case	R <sub>θJC</sub>	0.65	°C/W

Handling and Packaging — MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.

<sup>1</sup> 



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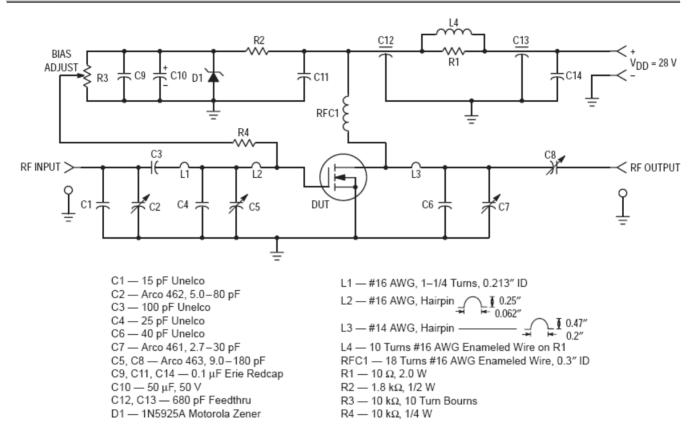
ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted.)

Characteristic	Symbol 3 -	Min	Тур	Max	Unit		
OFF CHARACTERISTICS							
Drain–Source Breakdown Voltage ( $V_{GS}$ = 0, I <sub>D</sub> = 50 mA)	V(BR)DSS	65	—	-	Vdc		
Zero Gate Voltage Drain Current ( $V_{DS}$ = 28 V, $V_{GS}$ = 0)	IDSS	—	—	10	mAdc		
Gate-Source Leakage Current (V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0)	IGSS	—	—	1.0	μAdc		
ON CHARACTERISTICS							
Gate Threshold Voltage ( $V_{DS}$ = 10 V, I <sub>D</sub> = 100 mA)	VGS(th)	1.0	3.0	6.0	Vdc		
Forward Transconductance (V <sub>DS</sub> = 10 V, I <sub>D</sub> = 3.0 A)	9fs	1.75	2.5	—	mhos		
DYNAMIC CHARACTERISTICS							
Input Capacitance (V <sub>DS</sub> = 28 V, V <sub>GS</sub> = 0, f = 1.0 MHz)	Ciss	_	175	—	pF		
Output Capacitance ( $V_{DS}$ = 28 V, $V_{GS}$ = 0, f = 1.0 MHz)	Coss	—	190	—	pF		
Reverse Transfer Capacitance (V $_{DS}$ = 28 V, V $_{GS}$ = 0, f = 1.0 MHz)	Crss	—	40	—	pF		
FUNCTIONAL CHARACTERISTICS (Figure 1)							
Noise Figure (V <sub>DD</sub> = 28 Vdc, I <sub>D</sub> = 2.0 A, f = 150 MHz)	NF	—	3.0	_	dB		
Common Source Power Gain (V <sub>DD</sub> = 28 Vdc, P <sub>out</sub> = 125 W, f = 150 MHz, I <sub>DQ</sub> = 100 mA)	G <sub>ps</sub>	9.0	11.8	—	dB		
Drain Efficiency (V <sub>DD</sub> = 28 Vdc, P <sub>out</sub> = 125 W, f = 150 MHz, I <sub>DQ</sub> = 100 mA)	η	50	60	—	%		
Electrical Ruggedness (V <sub>DD</sub> = 28 Vdc, P <sub>out</sub> = 125 W, f = 150 MHz, I <sub>DQ</sub> = 100 mA, VSWR 30:1 at all Phase Angles)	Ψ	No Degradation in Output Power					



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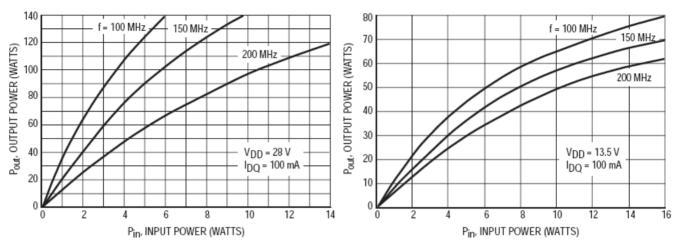


Figure 2. Output Power versus Input Power

Figure 3. Output Power versus Input Power

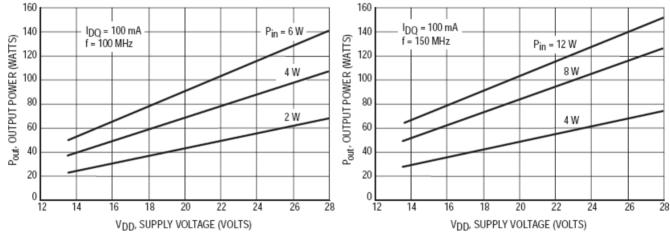


Figure 4. Output Power versus Supply Voltage

Figure 5. Output Power versus Supply Voltage



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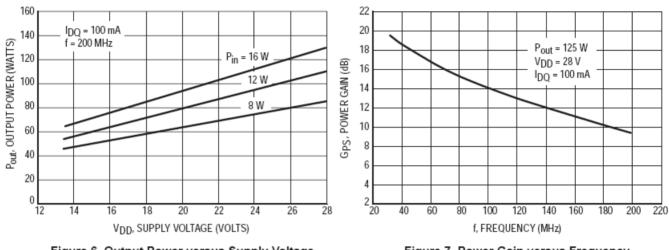


Figure 6. Output Power versus Supply Voltage



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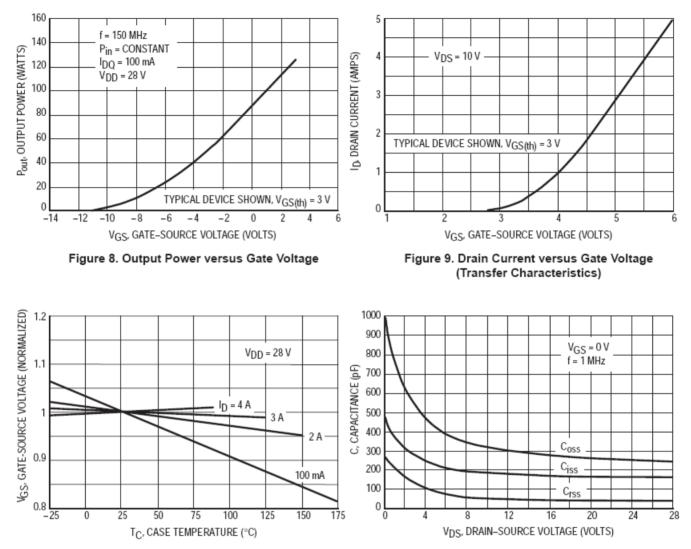


Figure 10. Gate-Source Voltage versus





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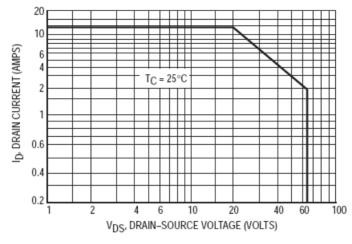
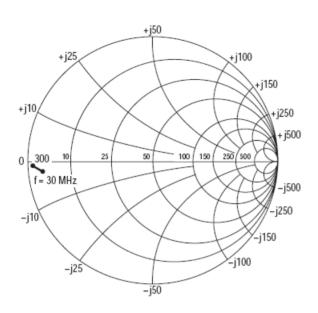
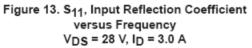


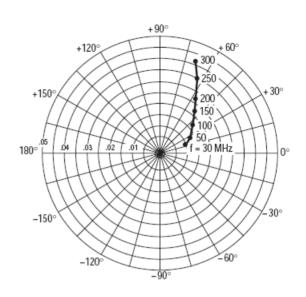
Figure 12. DC Safe Operating Area

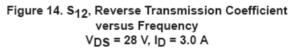


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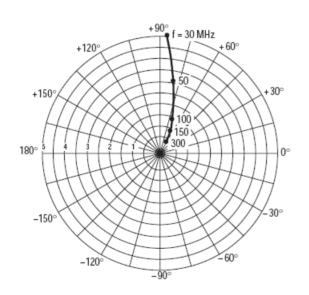
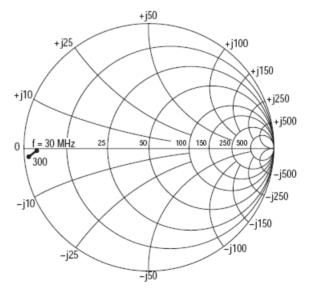
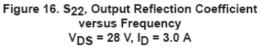


Figure 15. S<sub>21</sub>, Forward Transmission Coefficient versus Frequency V<sub>DS</sub> = 28 V, I<sub>D</sub> = 3.0 A





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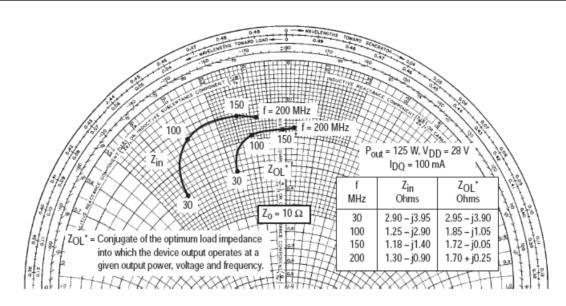


Figure 17. Series Equivalent Input/Output Impedance, Zin, ZOL\*



#### **DESIGN CONSIDERATIONS**

The MRF174 is a RF MOSFET power N-channel enhancement mode field-effect transistor (FET) designed for UHF power amplifier applications. M/A-COM RF MOSFETs feature a vertical structure with a planar design, thus avoiding the processing difficulties associated with V-groove power FETs.

M/A-COM Application Note AN211A, FETs in Theory and Practice, is suggested reading for those not familiar with the construction and characteristics of FETs.

The major advantages of RF power FETs include high gain, low noise, simple bias systems, relative immunity from thermal runaway, and the ability to withstand severely mismatched loads without suffering damage. Power output can be varied over a wide range with a low power dc control signal, thus facilitating manual gain control, ALC and modulation.

#### DC BIAS

The MRF174 is an enhancement mode FET and, therefore, does not conduct when drain voltage is applied. Drain current flows when a positive voltage is applied to the gate. See Figure 9 for a typical plot of drain current versus gate voltage. RF power FETs require forward bias for optimum performance. The value of quiescent drain current (IDQ) is not critical for many applications. The MRF174 was characterized at IDQ = 100 mA, which is the suggested minimum value of IDQ. For special applications such as linear amplification, IDQ may have to be selected to optimize the critical parameters.

The gate is a dc open circuit and draws no current. Therefore, the gate bias circuit may generally be just a simple resistive divider network. Some special applications may require a more elaborate bias system.

#### **GAIN CONTROL**

Power output of the MRF174 may be controlled from its rated value down to zero (negative gain) by varying the dc gate voltage. This feature facilitates the design of manual gain control, AGC/ALC and modulation systems. (see Figure 8.)

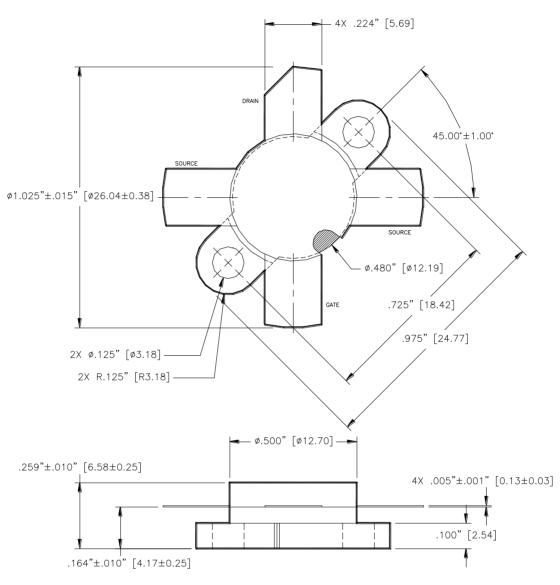
#### **AMPLIFIER DESIGN**

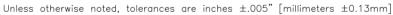
Impedance matching networks similar to those used with bipolar VHF transistors are suitable for MRF174. See M/A-COM Application Note AN721, Impedance Matching Networks Applied to RF Power Transistors. The higher input impedance of RF MOSFETs helps ease the task of broadband network design. Both small-signal scattering parameters and large-signal impedances are provided. While the sparameters will not produce an exact design solution for high power operation, they do yield a good first approximation. This is an additional advantage of RF MOS power FETs.

For further information and support please visit:



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